



500.38665CX1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): SHIMOKAWA, et al.

Serial No.: 09/972,178 ✓

Filed: October 9, 2001 ✓

For: PB-FREE SOLDER-CONNECTED STRUCTURE AND ELECTRONIC DEVICE

Group: 1775 ✓

Examiner: J. Zimmerman ✓

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MAR 21 2002

AMENDMENT

TC 1700

Assistant Commissioner for Patents
Washington, D.C. 20231

March 18, 2002

Sir:

In response to the Office Action mailed December 17, 2001, please amend the above-identified application as follows:

IN THE CLAIMS

Please cancel claims 15-18 and 28-39 without prejudice or disclaimer, and amend the claims remaining in the application as follows:

~~1. (Amended) An electronic device comprising a substrate and a semiconductor device, which are connected with each other by means of a Pb-~~